



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit 203.30	ppm	
752 9 SRT	Alumina Ceramic	Al2O3	0.8800	0.1789	87.50%	156.5410	77.00%	770000	
		SiO2 (silicon dioxide)			14808-60-7	12.50%	22.3630	11.00%	110000
					100.00%	178.9040			
	Conductor Thick Film	Ag	0.0068	0.0014	100.00%	1.3824	0.68%	6800	
					100.00%	1.3824			
	Resistor Thick Film	RuO2	0.0079	0.0016	30.00%	0.4818	0.24%	2370	
		PbO			1317-36-8	10.00%	0.1606	0.08%	790
		SiO2 (silicon dioxide)			14808-60-7	30.00%	0.4818	0.24%	2370
		B2O3			1303-86-2	30.00%	0.4818	0.24%	2370
					100.00%	1.6061			
	Notch Conductor Thick Film	Ag	0.0113	0.0023	100.00%	2.2973	1.13%	11300	
					100.00%	2.2973			
	Underplate	Ni	0.0250	0.0051	100.00%	5.0825	2.50%	25000	
					100.00%	5.0825			
	Finish Plate	Sn	0.0170	0.0035	100.00%	3.4561	1.70%	17000	
					100.00%	3.4561			
	Covercoat	TiO2	0.0520	0.0106	50.00%	5.2858	2.60%	26000	
		Silicone			218163-11-2	50.00%	5.2858	2.60%	26000
		Sum				1.0000	0.2033	100.00%	10.5716
			part weight	0.2033					
		Totals:		0.2033		203.30	100.00%	1000000	

RoHS exemption claimed for lead in glass of electronic component